

SSM6P54TU

- High-Speed Switching Applications
- Power Management Switch Applications

- 1.5 V drive
- Suitable for high-density mounting due to compact package
- Low on-resistance : $R_{ON} = 228 \text{ m}\Omega$ (max) (@ $V_{GS} = -2.5 \text{ V}$)
 : $R_{ON} = 350 \text{ m}\Omega$ (max) (@ $V_{GS} = -1.8 \text{ V}$)
 : $R_{ON} = 555 \text{ m}\Omega$ (max) (@ $V_{GS} = -1.5 \text{ V}$)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Drain-Source voltage	V_{DS}	-20	V
Gate-Source voltage	V_{GSS}	± 8	V
Drain current	DC	I_D	-1.2
	Pulse	I_{DP}	-2.4
Drain power dissipation	P_D (Note 1)	500	mW
Channel temperature	T_{ch}	150	°C
Storage temperature range	T_{stg}	-55 ~ 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

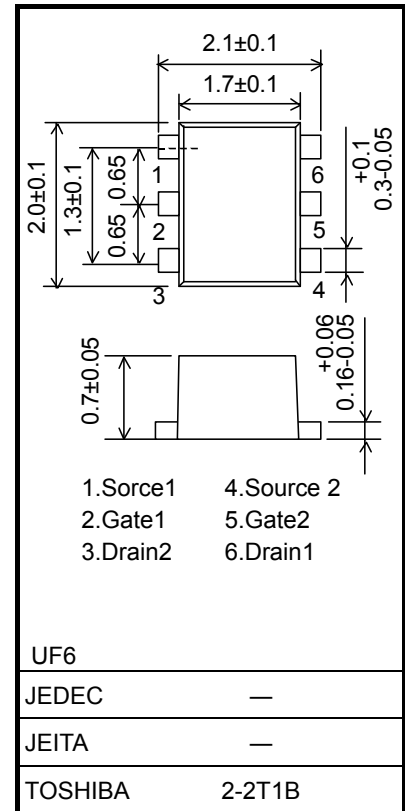
Note 1: Mounted on an FR4 board.
 (25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 645 mm²)

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20	—	—	V
	$V_{(BR)DSX}$	$I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$	-12	—	—	
Drain cut-off current	I_{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	—	—	-10	μA
Gate leakage current	I_{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0$	—	—	± 1	μA
Gate threshold voltage	V_{th}	$V_{DS} = -3 \text{ V}, I_D = -1 \text{ mA}$	-0.3	—	-1.0	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -3 \text{ V}, I_D = -0.6 \text{ A}$ (Note 2)	1.7	3.4	—	S
Drain-Source on-resistance	$R_{DS(ON)}$	$I_D = -0.6 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 2)	—	162	228	mΩ
		$I_D = -0.6 \text{ A}, V_{GS} = -1.8 \text{ V}$ (Note 2)	—	212	350	
		$I_D = -0.1 \text{ A}, V_{GS} = -1.5 \text{ V}$ (Note 2)	—	249	555	
Input capacitance	C_{iss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0$ $f = 1 \text{ MHz}$	—	331	—	pF
Output capacitance	C_{oss}		—	48	—	
Reverse transfer capacitance	C_{rss}		—	39	—	
Switching time	Turn-on time	t_{on}	—	19	—	ns
	Turn-off time	t_{off}	—	18	—	
Total gate charge	Q_g	$V_{DS} = -16 \text{ V}, I_{DS} = -1.2 \text{ A},$ $V_{GS} = -4 \text{ V}$	—	7.7	—	nC
Gate-Source charge	Q_{gs}		—	4.9	—	
Gate-Drain charge	Q_{gd}		—	2.8	—	
Drain-Source forward voltage	V_{DSF}	$I_D = 1.2 \text{ A}, V_{GS} = 0$ (Note 2)	—	0.8	1.2	V

Note 2: Pulse test

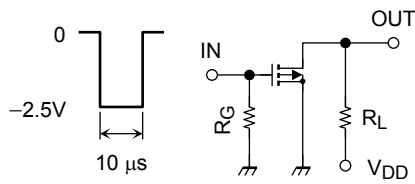
Unit : mm



Weight: 7.0 mg (typ.)

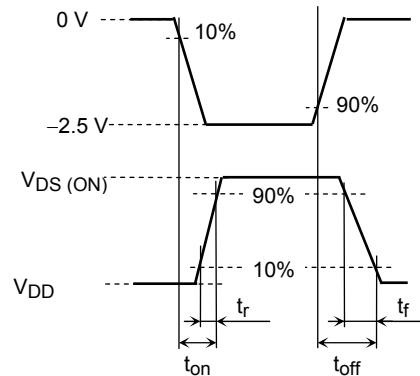
Switching Time Test Circuit

(a) Test Circuit



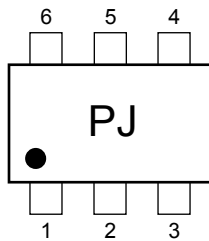
$V_{DD} = -10\text{ V}$
 $R_G = 4.7\ \Omega$
 $D.U. \leq 1\%$
 $V_{IN}: t_r, t_f < 5\text{ ns}$
 Common Source
 $T_a = 25\text{ }^\circ\text{C}$

(b) V_{IN}

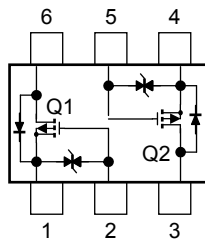


(c) V_{OUT}

Marking



Equivalent Circuit (top view)



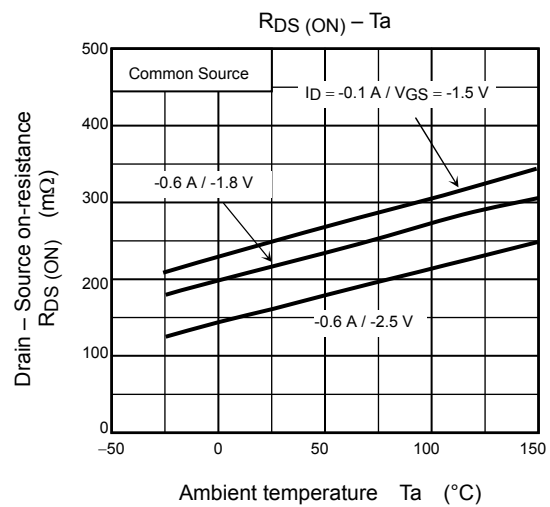
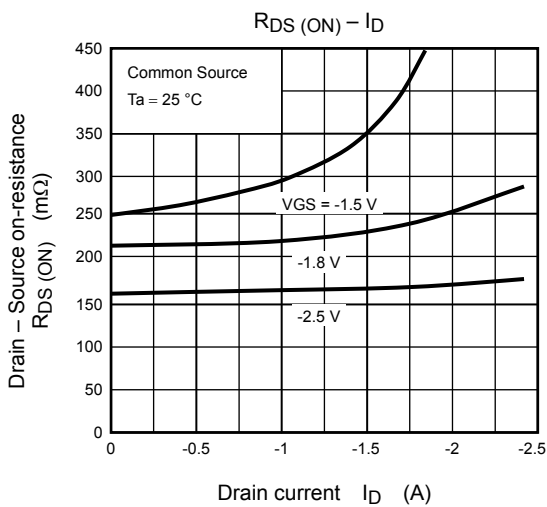
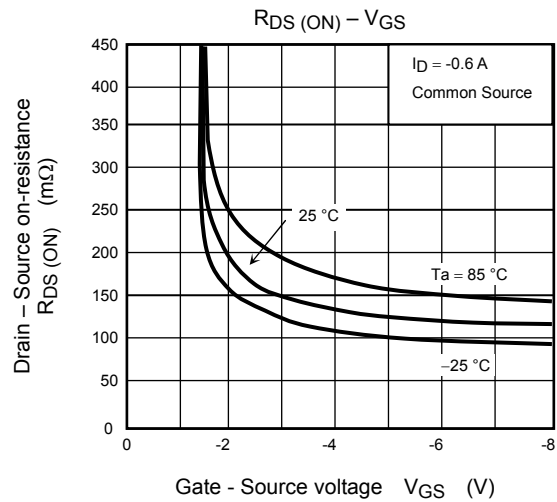
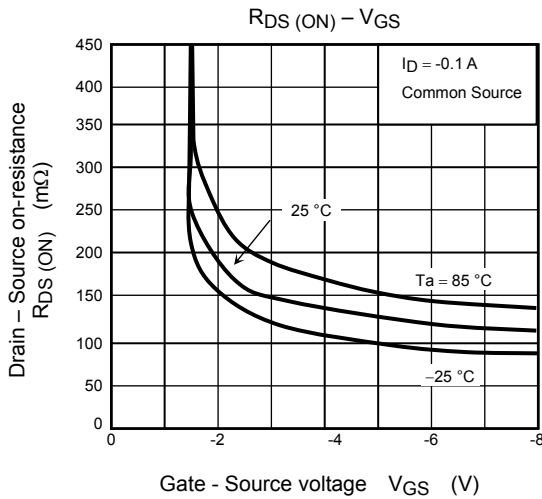
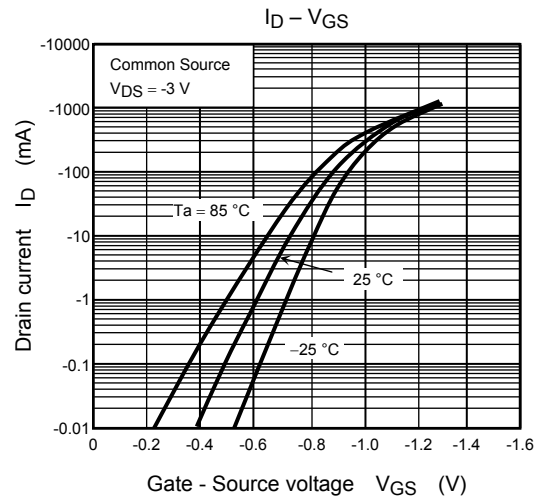
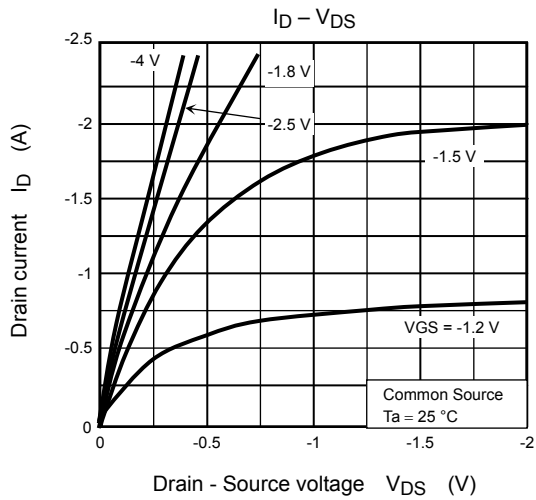
Precaution

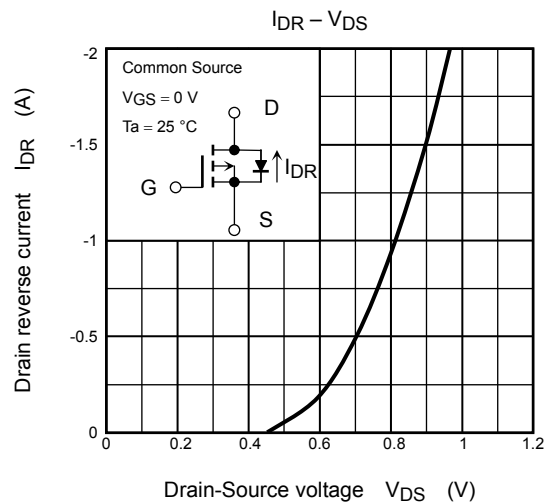
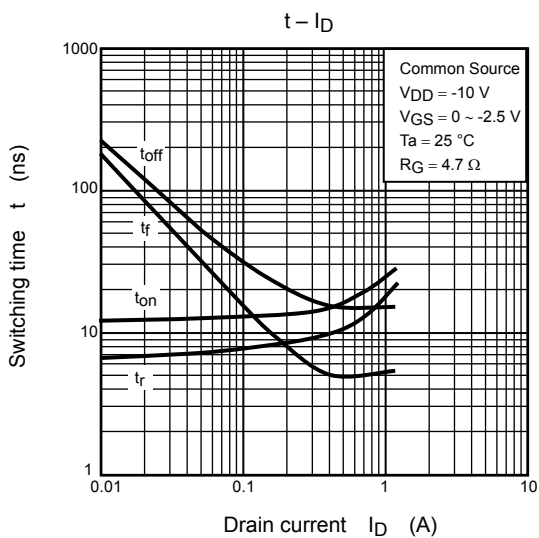
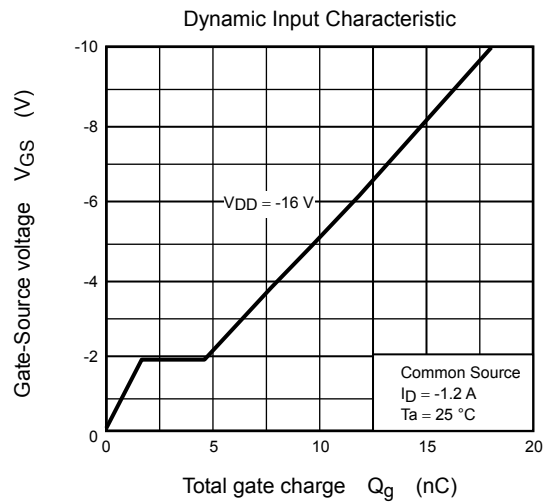
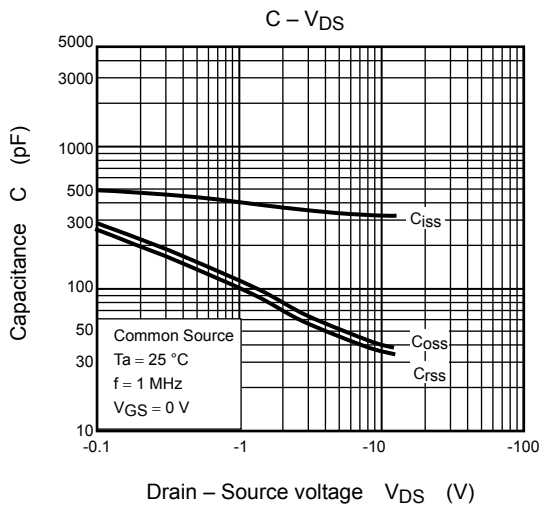
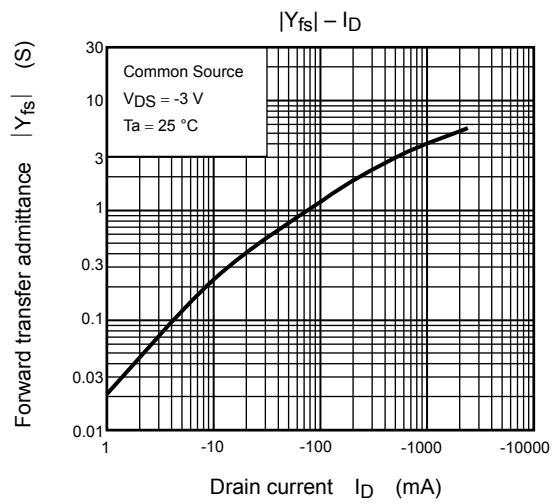
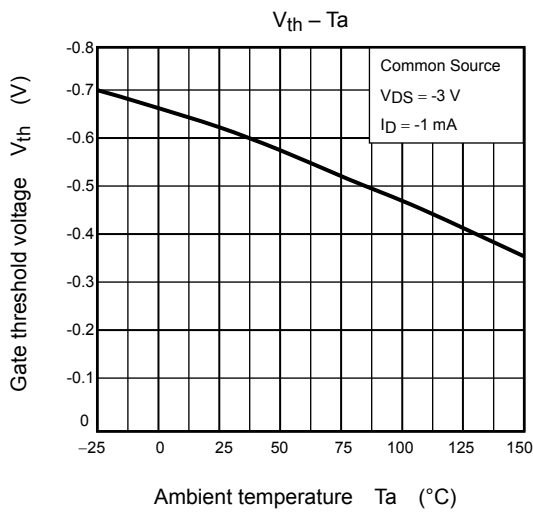
V_{th} can be expressed as the voltage between the gate and source when the low operating current value is $I_D = -1\text{ mA}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires a higher voltage than V_{th} and $V_{GS(OFF)}$ requires a lower voltage than V_{th} . (The relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$.)

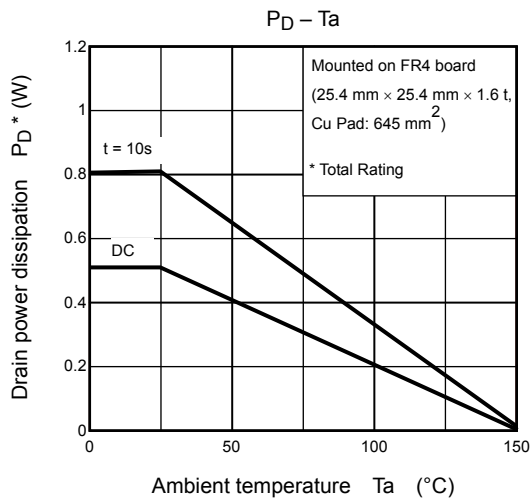
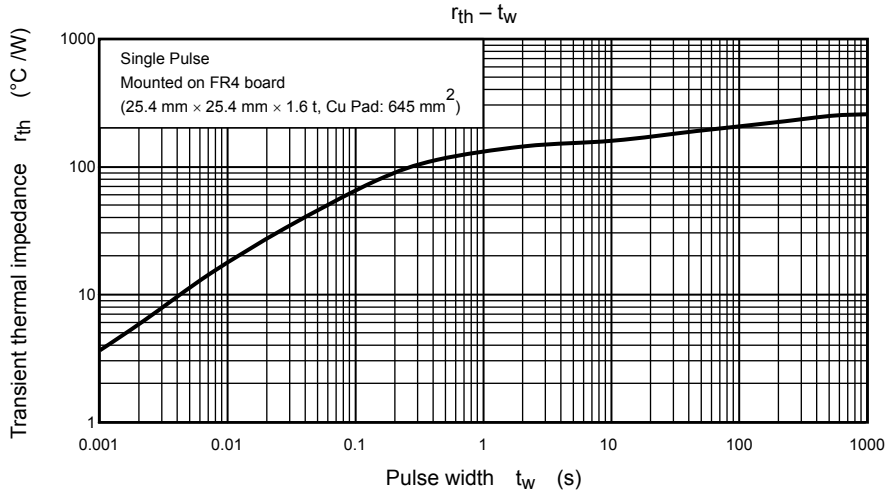
Be sure to take this into consideration when using the device.

Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.







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20070701-EN GENERAL

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